

Engineering Graduates Working in Connecticut

Let the State of
Connecticut
help you repay
your student loans
through the new

Connecticut Engineering Loan Reimbursement Program



Board of Governors for
Higher Education
Department of Higher Education
State of Connecticut

Engineers are crucial to Connecticut's growing economy. That's why the State of Connecticut has launched a new program to help engineers pay back their student loans.

The *Connecticut Engineering Loan Reimbursement Program* will pay up to \$5,000 of student loans to individuals who:

- are legal residents of Connecticut;
- have outstanding student loans in their names;
- have earned an undergraduate or graduate degree in engineering from any college or university in the U.S.; and
- have been hired as a full-time engineer in Connecticut after December 31, 2005.

Successful applicants will receive one payment as a reimbursement for qualifying student loans. Verification of student loans is required at the time of award notification.

To apply, mail or fax a completed application (see next page) by **March 30, 2007** to the Connecticut Department of Higher Education. With your application, include an official copy of your academic transcript indicating degrees and dates on which they were awarded. Include major concentration of study.

Applicants will be notified in writing about their award by June 1, 2007. The Department of Higher Education anticipates making 50 awards this year.

For questions or more information, contact the Education & Employment Information Center's (EEIC) toll-free Hotline at 800-842-0229 or eeic@ctdhe.org.

Connecticut Engineering Loan Reimbursement Program

Connecticut Department of Higher Education
61 Woodland Street, Hartford CT 06105-2326
www.ctdhe.org • eeic@ctdhe.org

Connecticut Engineering Loan Reimbursement Program Application

Please review this program's eligibility requirements before completing this application. Part I is to be completed by the applicant. Part II is to be completed by the applicant's employer. Submit your completed application and academic transcript by **March 30, 2007** to:

Connecticut Engineering Loan Reimbursement Program,

Connecticut Department of Higher Education, 61 Woodland Street, Hartford CT 06105-2326 • Fax 860-947-1311

PART I - TO BE COMPLETED BY APPLICANT (Please Type or Print)

Name _____ Social Security Number _____
(LAST, FIRST, MI)

Permanent Mailing Address (Street) _____
(City) _____ (State) _____ (Zip) _____

Home Phone (_____) _____ Alternate Phone (_____) _____ E-Mail _____

Undergraduate Study Completed at: _____

Major _____ Date Degree Awarded: Mo/Year _____ / _____

Graduate Study Completed at: _____

Major _____ Date Degree Awarded: Mo/Year _____ / _____

Outstanding Student Loans (must be in the applicant's name – consumer loans, e.g. credit cards do not qualify. List additional student loans on an attached page.)

Source _____ Amount _____

Source _____ Amount _____

Source _____ Amount _____

Source _____ Amount _____

I attest that the information provided on this application is true and correct. By signing, I agree to participate in future data collection regarding status and place of employment for program evaluation purposes only.

X _____
APPLICANT'S SIGNATURE DATE

PART II - TO BE COMPLETED BY APPLICANT'S EMPLOYER

I attest that _____ is currently employed full-time as a _____
APPLICANT NAME POSITION TITLE

with _____ Employee was hired on _____
EMPLOYER NAME DATE

and started working full-time in his/her current position on _____ Current Employee Annual Salary _____
DATE

VERIFYING OFFICIAL (PLEASE PRINT) TITLE

SIGNATURE DATE

Mailing Address _____

Telephone (_____) _____ FAX (_____) _____ E-Mail _____